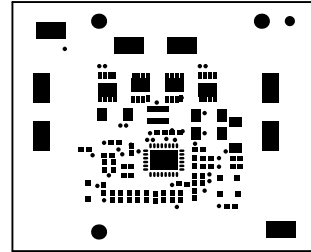
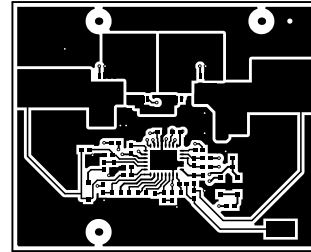


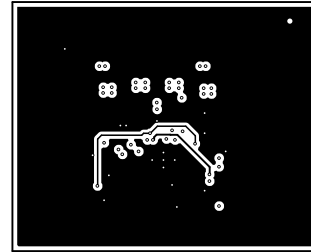
| | | | |
|----------------------------------|----------------------|------------|--------------------------------|
| ALL ARTWORK VIEWED FROM TOP SIDE | BOARD #: PMP20107 | REV: A | SUN REV: Not In VersionControl |
| LAYER NAME = Top Overlay | TID #: PMP20107 | | |
| PLOT NAME = Top Overlay | GENERATED : 6/3/2016 | 3:17:24 PM | TEXAS INSTRUMENTS |



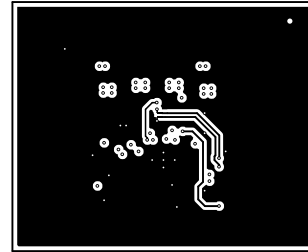
| | | | |
|----------------------------------|---------------------------------|-------------------|--------------------------------|
| ALL ARTWORK VIEWED FROM TOP SIDE | BOARD #: PMP20107 | REV: A | SUN REV: Not In VersionControl |
| LAYER NAME = Top Solder | TID #: PMP20107 | | |
| PLOT NAME = Top Solder Mask | GENERATED : 6/3/2016 3:17:25 PM | TEXAS INSTRUMENTS | |



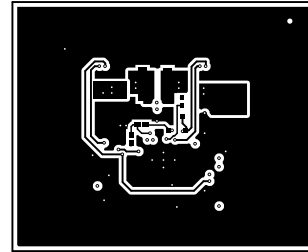
| | | | |
|----------------------------------|----------------------|------------|--------------------------------|
| ALL ARTWORK VIEWED FROM TOP SIDE | BOARD #: PMP20107 | REV: A | SUN REV: Not In VersionControl |
| LAYER NAME = Top Layer | TID #: PMP20107 | | |
| PLOT NAME = Top Layer | GENERATED : 6/3/2016 | 3:17:26 PM | TEXAS INSTRUMENTS |



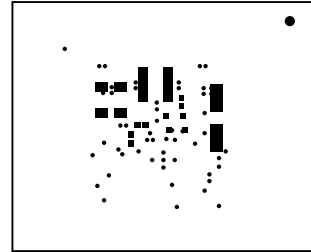
| | | | |
|----------------------------------|----------------------|------------|--------------------------------|
| ALL ARTWORK VIEWED FROM TOP SIDE | BOARD #: PMP20107 | REV: A | SUN REV: Not In VersionControl |
| LAYER NAME = | TID #: PMP20107 | | |
| PLOT NAME = Signal Layer 1 | GENERATED : 6/3/2016 | 3:17:27 PM | TEXAS INSTRUMENTS |



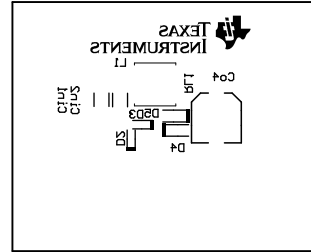
| | | | |
|----------------------------------|----------------------|------------|--------------------------------|
| ALL ARTWORK VIEWED FROM TOP SIDE | BOARD #: PMP20107 | REV: A | SUN REV: Not In VersionControl |
| LAYER NAME = | TID #: PMP20107 | | |
| PLOT NAME = Signal Layer 2 | GENERATED : 6/3/2016 | 3:17:27 PM | TEXAS INSTRUMENTS |



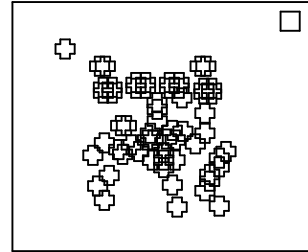
| | | | |
|----------------------------------|----------------------|------------|--------------------------------|
| ALL ARTWORK VIEWED FROM TOP SIDE | BOARD #: PMP20107 | REV: A | SUN REV: Not In VersionControl |
| LAYER NAME = Bottom Layer | TID #: PMP20107 | | |
| PLOT NAME = Bottom Layer | GENERATED : 6/3/2016 | 3:17:28 PM | TEXAS INSTRUMENTS |



| | | | |
|----------------------------------|---------------------------------|-------------------|--------------------------------|
| ALL ARTWORK VIEWED FROM TOP SIDE | BOARD #: PMP20107 | REV: A | SUN REV: Not In VersionControl |
| LAYER NAME = Bottom Solder | TID #: PMP20107 | | |
| PLOT NAME = Bottom Solder Mask | GENERATED : 6/3/2016 3:17:29 PM | TEXAS INSTRUMENTS | |

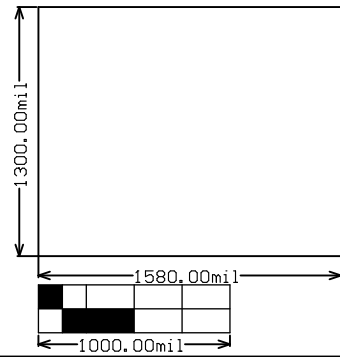


| | | | |
|----------------------------------|---------------------------------|-------------------|--------------------------------|
| ALL ARTWORK VIEWED FROM TOP SIDE | BOARD #: PMP20107 | REV: A | SUN REV: Not In VersionControl |
| LAYER NAME = Bottom Overlay | TID #: PMP20107 | | |
| PLOT NAME = Bottom Overlay | GENERATED : 6/3/2016 3:17:30 PM | TEXAS INSTRUMENTS | |



| Symbol | Quantity | Finished Hole Size | Plated | Hole Type |
|----------|----------|--------------------|--------|-----------|
| ⊕ | 60 | 10.00mil (0.254mm) | PTH | Round |
| □ | 1 | 28.00mil (0.711mm) | PTH | Round |
| 61 Total | | | | |

| | | | |
|----------------------------------|----------------------|------------|--------------------------------|
| ALL ARTWORK VIEWED FROM TOP SIDE | BOARD #: PMP20107 | REV: A | SUN REV: Not In VersionControl |
| LAYER NAME = Drill Drawing | TID #: PMP20107 | | |
| PLOT NAME = Drill Drawing | GENERATED : 6/3/2016 | 3:17:31 PM | TEXAS INSTRUMENTS |



| | | | |
|----------------------------------|----------------------|------------|--------------------------------|
| ALL ARTWORK VIEWED FROM TOP SIDE | BOARD #: PMP20107 | REV: A | SUN REV: Not In VersionControl |
| LAYER NAME = M2 Board Dimensions | TID #: PMP20107 | | |
| PLOT NAME = Board Dimensions | GENERATED : 6/3/2016 | 3:17:32 PM | TEXAS INSTRUMENTS |

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